AUTOMOTIVE

RoHS

COMPLIANT

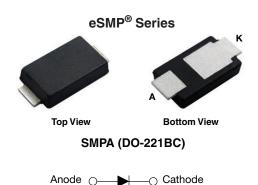
HALOGEN

**FREE** 



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



#### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS                                |                 |  |  |
|--|-----------------|--|--|
| I <sub>F(AV)</sub>                                     | 8.0 A           |  |  |
| $V_{RRM}$  | 60 V            |  |  |
| I <sub>FSM</sub>                                       | 100 A           |  |  |
| $V_F$ at $I_F = 8.0 \text{ A } (T_A = 125 \text{ °C})$ | 0.49 V          |  |  |
| T <sub>J</sub> max.                                    | 150 °C          |  |  |
| Package  | SMPA (DO-221BC) |  |  |
| Circuit configuration                                  | Single          |  |  |

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- · Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| <b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)             |                                   |             |      |  |
|--|-----------------------------------|-------------|------|--|
| PARAMETER  | SYMBOL                            | V8PA6       | UNIT |  |
| Device marking code  |                                   | V86         |      |  |
| Maximum repetitive peak reverse voltage  | V <sub>RRM</sub>                  | 60          | V    |  |
| Maximum DC forward current   | I <sub>F(AV)</sub> (1)            | 8.0         | Α    |  |
|  | I <sub>F(AV)</sub> (2)            | 3.2         |      |  |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I <sub>FSM</sub>                  | 100         | А    |  |
| Operating junction and storage temperature range                                   | T <sub>J</sub> , T <sub>STG</sub> | -40 to +150 | °C   |  |

#### Notes

- (1) Units mounted on 3 cm x 3 cm aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted) |                        |   |                               |      |      |      |
|---|------------------------|---|-------------------------------|------|------|------|
| PARAMETER   | TEST CONDITIONS        |   | SYMBOL                        | TYP. | MAX. | UNIT |
| Instantaneous forward voltage   | I <sub>F</sub> = 4.0 A | T. − 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.48 | -    | V    |
|   | $I_F = 8.0 A$          |   |                               | 0.55 | 0.63 |      |
|   | $I_F = 4.0 \text{ A}$  | T <sub>A</sub> = 125 °C                           |                               | 0.38 | -    |      |
|   | I <sub>F</sub> = 8.0 A |   |                               | 0.49 | 0.57 |      |
| Reverse current   | V <sub>R</sub> = 60 V  | T <sub>A</sub> = 25 °C<br>T <sub>A</sub> = 125 °C | I <sub>R</sub> <sup>(2)</sup> | -    | 0.6  | - mA |
|   | v <sub>R</sub> = 60 v  | T <sub>A</sub> = 125 °C                           |                               | 14   | 30   |      |
| Typical junction capacitance  | 4.0 V, 1 MHz           |   | CJ                            | 1030 | -    | pF   |

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5 \text{ ms}$ 

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified) |                         |       |      |  |
|---|-------------------------|-------|------|--|
| PARAMETER   | SYMBOL                  | V8PA6 | UNIT |  |
| Typical thermal resistance  | R <sub>θJA</sub> (1)(2) | 100   | °C/W |  |
|   | R <sub>0JM</sub> (3)    | 5     |      |  |

#### **Notes**

- $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta,JA}$  junction to ambient
- $^{(3)}$  Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance  $R_{\theta JM}$  junction to mount

| ORDERING INFORMATION (Example) |                 |                        |               |                                    |  |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |  |
| V8PA6-M3/I                     | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |  |
| V8PA6HM3/I (1)                 | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |  |

### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

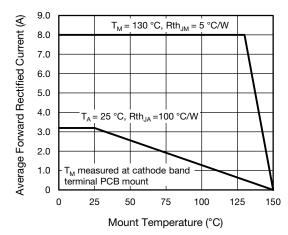


Fig. 1 - Maximum Forward Current Derating Curve

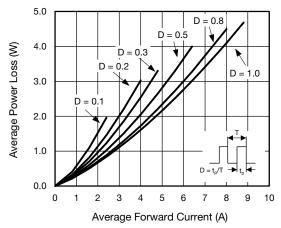


Fig. 2 - Forward Power Loss Characteristics



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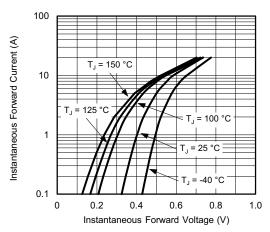


Fig. 3 - Typical Instantaneous Forward Characteristics

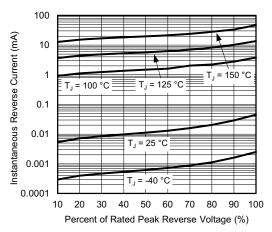


Fig. 4 - Typical Reverse Leakage Characteristics

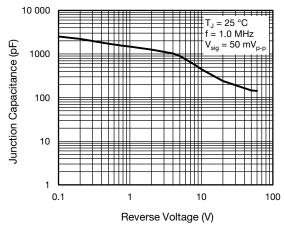


Fig. 5 - Typical Junction Capacitance

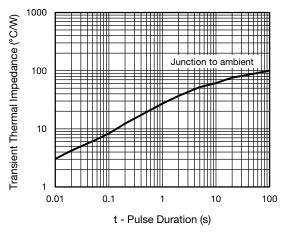


Fig. 6 - Typical Transient Thermal Impedance

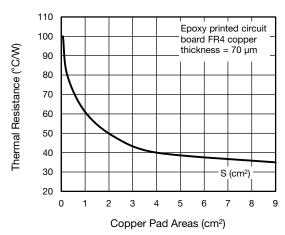


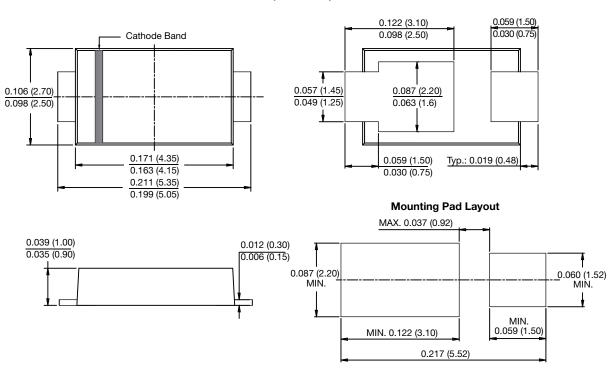
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### **SMPA (DO-221BC)**





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